

Octal buffer with 30Ω equivalent output termination (3-State)

74F2244

FEATURES

- Octal bus interface
- 30Ω output termination ideal for driving DRAM
- 15mA source current
- SSOP Type II Package

DESCRIPTION

The 74F2244 is an octal buffer that is ideal for driving dynamic DRAM with matching impedance. The outputs are all capable of sinking 5mA and sourcing up to 15mA. The device features two output enables, OEa and OEb, each controlling four of the 3-state outputs.

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F2244	4.0ns	30mA

ORDERING INFORMATION

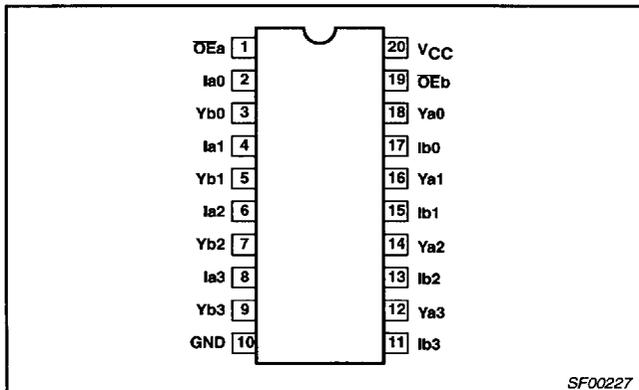
DESCRIPTION	ORDER CODE	DRAWING NUMBER
	COMMERCIAL RANGE V _{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	
20-pin plastic DIP	N74F2244N	SOT146-1
20-pin plastic SOL	N74F2244D	SOT163-1
20-pin plastic SSOP Type II	N74F2244DB	SOT339-1

INPUT AND OUTPUT LOADING AND FAN OUT TABLE

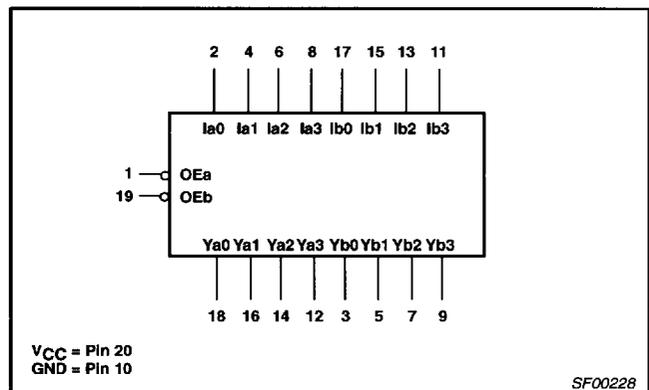
PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Ia _n , Ib _n	Data inputs	1.0/0.33	20μA/0.2mA
OEa, OEb	Output enable inputs (active low)	1.0/0.33	20μA/0.2mA
Ya _n , Yb _n	Data outputs	750/8.33	15mA/5mA

NOTE: One (1.0) FAST unit load is defined as: 20μA in the high state and 0.6mA in the low state.

PIN CONFIGURATION



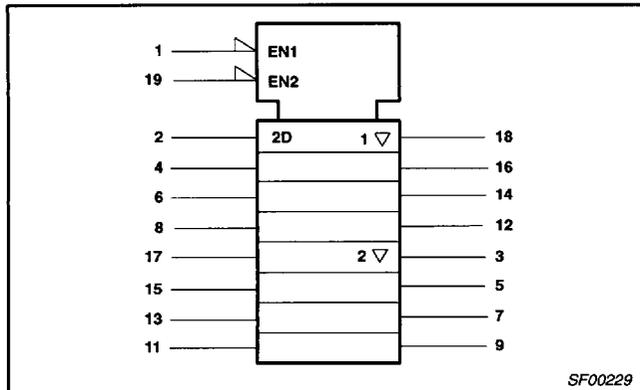
LOGIC SYMBOL



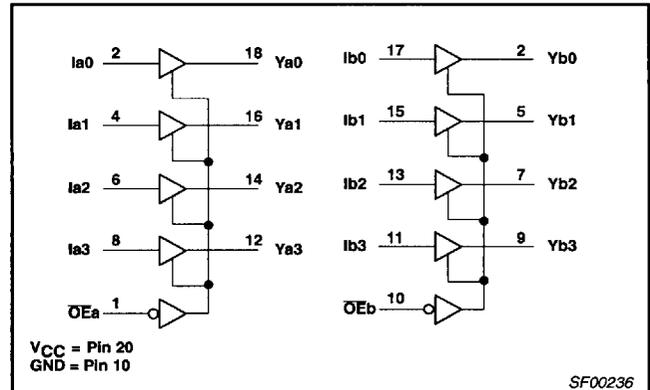
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IEC/IEEE SYMBOL



LOGIC DIAGRAM



FUNCTION TABLE

INPUTS				OUTPUTS	
OEa	Ia	OEb	Ib	Ya	Yb
L	L	L	L	L	L
L	H	L	H	H	H
H	X	H	X	Z	Z

Notes to function table

- H = High voltage level
- L = Low voltage level
- X = Don't care
- Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	-30 to +5	mA
V _{OUT}	Voltage applied to output in high output state	-0.5 to V _{CC}	V
I _{OUT}	Current applied to output in low output state	10	mA
T _{amb}	Operating free air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
I _{ik}	Input clamp current			-18	mA
I _{OH}	High-level output current			-15	mA
I _{OL}	Low-level output current			5	mA
T _{amb}	Operating free air temperature range	0		+70	°C

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DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS ¹			LIMITS			UNIT
					MIN	TYP ²	MAX	
V _{OH}	High-level output voltage	V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN	I _{OH} = -3mA	±10%V _C	2.5			V
				±5%V _{CC}	2.7	3.4		V
			I _{OH} = -15mA	±10%V _C	2.0			V
				±5%V _{CC}	2.0			V
V _{OL}	Low-level output voltage	V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN,	I _{OL} = MAX	±10%V _C			0.50	V
				±5%V _{CC}		0.42	0.50	V
V _{IK}	Input clamp voltage	V _{CC} = MIN, I _I = I _{IK}				-0.73	-1.2	V
I _I	Input current at maximum input voltage	V _{CC} = MAX, V _I = 7.0V					100	μA
I _{IH}	High-level input current	V _{CC} = MAX, V _I = 2.7V					20	μA
I _{IL}	Low-level input current	V _{CC} = MAX, V _I = 0.5V					-0.2	mA
I _{OZH}	Off-state output current, high-level voltage applied	V _{CC} = MAX, V _O = 2.7V					50	μA
I _{OZL}	Off-state output current, low-level voltage applied	V _{CC} = MAX, V _O = 0.5V					-50	μA
I _{OS}	Short-circuit output current ³	V _{CC} = MAX			-60		-150	mA
I _{CC}	Supply current (total)	V _{CC} = MAX	I _{CCH}			20	30	mA
			I _{CCL}			45	65	mA
			I _{CCZ}			26	40	mA

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
- Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

AC ELECTRICAL CHARACTERISTICS

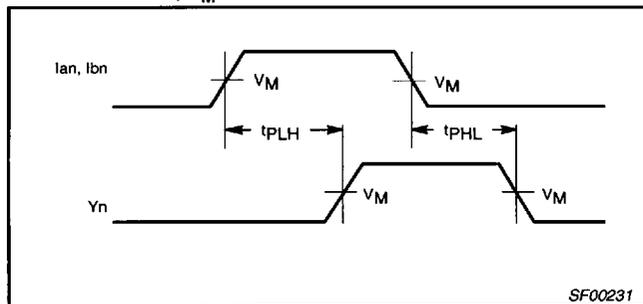
SYMBOL	PARAMETER	TEST CONDITION	LIMITS					UNIT
			T _{amb} = +25°C			T _{amb} = 0°C to +70°C		
			MIN	TYP	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay I _{an} , I _{bn} to Y _n	Waveform 1	3.0 2.5	4.5 4.5	7.0 7.0	2.5 2.5	8.0 7.5	ns
t _{PZH} t _{PZL}	Output enable time to high or low level	Waveform 2 Waveform 3	2.5 3.0	4.5 5.0	7.5 8.0	2.0 3.0	8.0 8.5	ns
t _{PHZ} t _{PLZ}	Output disable time from high or low level	Waveform 2 Waveform 3	1.5 1.5	3.5 2.5	6.0 5.5	1.0 1.0	6.0 5.5	ns

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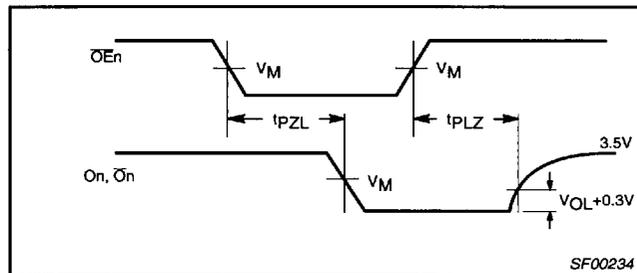
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AC WAVEFORMS

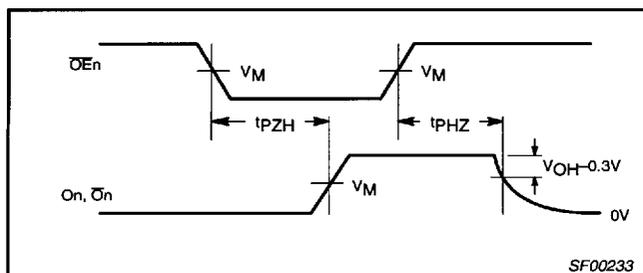
For all waveforms, $V_M = 1.5V$.



Waveform 1. Propagation delay for data to outputs



Waveform 3. 3-State output enable time to low level and output disable time from low level

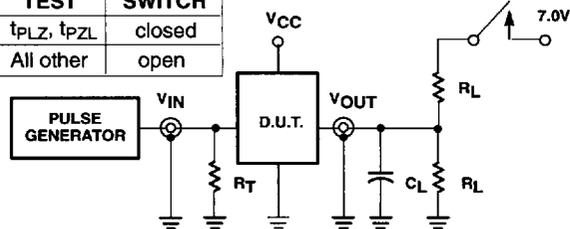


Waveform 2. 3-State output enable time to high level and output disable time from high level

TEST CIRCUIT AND WAVEFORMS

SWITCH POSITION

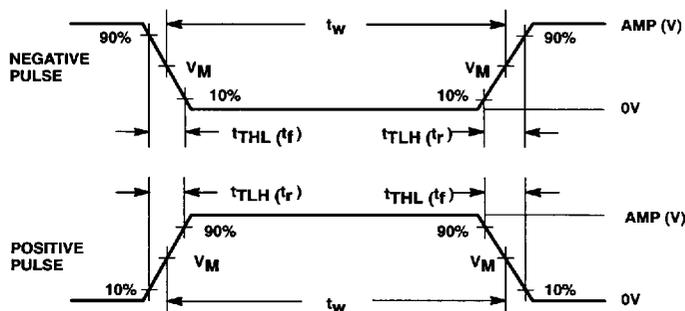
TEST	SWITCH
t_{PLZ} , t_{PZL}	closed
All other	open



Test circuit for 3-State outputs

DEFINITIONS:

- R_L = Load resistor; see AC electrical characteristics for value.
- C_L = Load capacitance includes jig and probe capacitance; see AC electrical characteristics for value
- R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.



Input pulse definition

family	INPUT PULSE REQUIREMENTS					
	amplitude	V_M	rep. rate	t_w	t_{TLH}	t_{THL}
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns

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